

FDB047N10

N-Channel PowerTrench[®] MOSFET 100V, 164A, 4.7m Ω

Description

- $R_{DS(on)} = 3.9 \text{m}\Omega$ (Typ.) @ $V_{GS} = 10 \text{V}$, $I_{D} = 75 \text{A}$
- · Fast switching speed
- · Low gate charge
- High performance trench technology for extremely low R_{DS(on)}
- High power and current handing capability
- · RoHS compliant



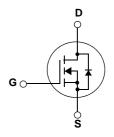
General Description

This N-Channel MOSFET is producedusing Fairchild Semiconductor's advance PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

• DC to DC converters / Synchronous Rectification





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

| Symbol | | Parameter | | Ratings | Units |
|-----------------------------------|--|--|----------|---------|-------|
| V_{DSS} | Drain to Source Voltage | | | 100 | V |
| V_{GSS} | Gate to Source Voltage | | | ±20 | V |
| | Drain Current - Co | ntinuous (T _C = 25°C, Silicon Lim | nited) | 164* | А |
| I _D | - Co | ontinuous (T _C = 100°C, Silicon Lin | nited) | 116* | А |
| | - Co | ontinuous (T _C = 25°C, Package L | _imited) | 120 | А |
| I _{DM} | Drain Current | - Pulsed (Note 1) | | 656* | А |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | (Note 2) | 1153 | mJ |
| dv/dt | Peak Diode Recovery dv/dt | | (Note 3) | 4.5 | V/ns |
| D | Dower Discipation | (T _C = 25°C) | | 375 | W |
| P_{D} | Power Dissipation - Derate above 25°C | | | 2.5 | W/°C |
| T _J , T _{STG} | Operating and Storage Temper | Operating and Storage Temperature Range | | | °C |
| TL | Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds | | | 300 | °C |

^{*}Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

Thermal Characteristics

| Symbol | Parameter | Ratings | Units |
|-----------------|--|---------|-------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 0.4 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient 62.5 | | C/VV |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|-----------|---------|-----------|------------|----------|
| FDB047N10 | FDB047N10 | D2-PAK | 330mm | 24mm | 800 |

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

| Parameter Test Conditions | | Min. | Тур. | Max. | Units |
|---|---|------|------|------|-------|
| cteristics | | | | | |
| Drain to Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V, T_J = 25^{\circ} C$ | 100 | - | - | V |
| Breakdown Voltage Temperature Coefficient | I _D = 250μA, Referenced to 25°C | - | 0.1 | - | V/ºC |
| Zoro Gato Voltago Drain Current | V _{DS} = 100V, V _{GS} = 0V | - | - | 1 | |
| Zero Gate voltage Drain Current | $V_{DS} = 100V, V_{GS} = 0V, T_{C} = 150^{\circ}C$ | - | - | 500 | μΑ |
| Gate to Body Leakage Current | $V_{GS} = \pm 20V, V_{DS} = 0V$ | - | - | ±100 | nA |
| | Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current | | | | |

On Characteristics

| V _{GS(th)} | Gate Threshold Voltage | $V_{GS} = V_{DS}, I_{D} = 250 \mu A$ | 2.5 | 3.5 | 4.5 | V |
|---------------------|--------------------------------------|--------------------------------------|-----|-----|-----|----|
| R _{DS(on)} | Static Drain to Source On Resistance | $V_{GS} = 10V, I_D = 75A$ | ı | 3.9 | 4.7 | mΩ |
| 9 _{FS} | Forward Transconductance | $V_{DS} = 10V, I_D = 75A$ (Note 4) | i | 170 | ı | S |

Dynamic Characteristics

| C _{iss} | Input Capacitance | V 25V V 2V | - | 11500 | 15265 | pF |
|------------------|------------------------------|---|---|-------|-------|----|
| C _{oss} | Output Capacitance | $V_{DS} = 25V, V_{GS} = 0V$ f = 1MHz | ı | 1120 | 1500 | pF |
| C _{rss} | Reverse Transfer Capacitance | 1 - 1101112 | - | 455 | 680 | pF |

Switching Characteristics

| t _{d(on)} | Turn-On Delay Time | | | - | 174 | 358 | ns |
|---------------------|-------------------------------|---|-----------|---|-----|-----|----|
| t _r | Turn-On Rise Time | $V_{DD} = 50V, I_{D} = 75A$ | | - | 386 | 782 | ns |
| t _{d(off)} | Turn-Off Delay Time | $V_{GS} = 10V, R_{GEN} = 25\Omega$ | | - | 344 | 698 | ns |
| t _f | Turn-Off Fall Time | (No | ote 4, 5) | - | 244 | 499 | ns |
| Q _{g(tot)} | Total Gate Charge at 10V | V _{DS} = 80V, I _D = 75A | | - | 160 | 210 | nC |
| Q _{gs} | Gate to Source Gate Charge | $V_{GS} = 30V$, $V_{GS} = 10V$ | | - | 56 | - | nC |
| Q_{gd} | Gate to Drain "Miller" Charge | | ote 4, 5) | - | 36 | - | nC |

Drain-Source Diode Characteristics

| I_S | Maximum Continuous Drain to Source Diode Forward Current | | | - | - | 164 | Α |
|-----------------|--|-----------------------------|----------|---|-----|------|----|
| I _{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | | - | - | 656 | Α |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS} = 0V, I_{SD} = 75A$ | | - | - | 1.25 | V |
| t _{rr} | Reverse Recovery Time | $V_{GS} = 0V, I_{SD} = 75A$ | | = | 88 | - | ns |
| Q _{rr} | Reverse Recovery Charge | $dI_F/dt = 100A/\mu s$ | (Note 4) | - | 245 | - | nC |

Notes

- Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 0.41mH, I_{AS} = 75A, V_{DD} = 50V, R_{G} = 25 $\!\Omega$, Starting T_{J} = 25°C
- 3. I_{SD} \leq 75A, di/dt \leq 200A/µs, V_{DD} \leq BV_DSS, Starting T_J = 25°C
- 4. Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%
- 5. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

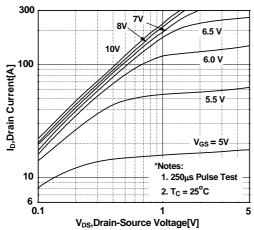


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

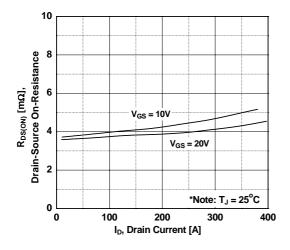


Figure 5. Capacitance Characteristics

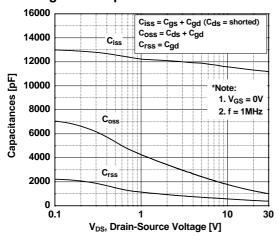


Figure 2. Transfer Characteristics

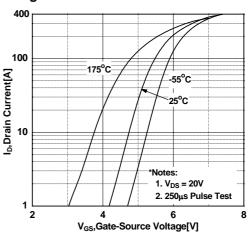


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

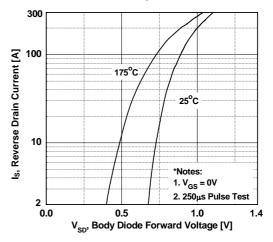
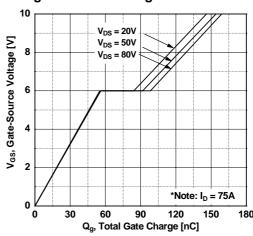


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

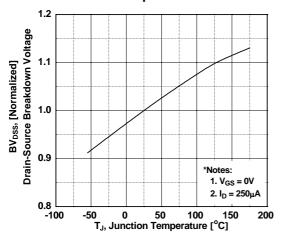


Figure 9. Maximum Safe Operating Area

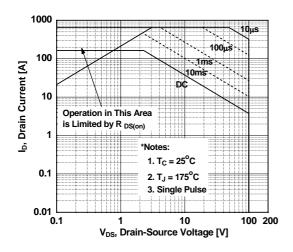


Figure 8. On-Resistance Variation vs. Temperature

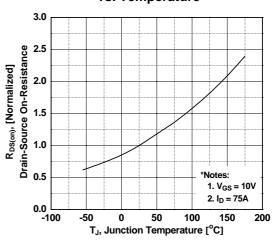


Figure 10. Maximum Drain Current vs. Case Temperature

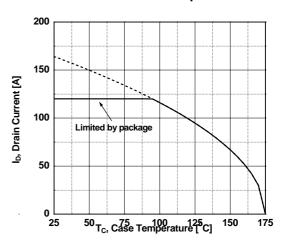
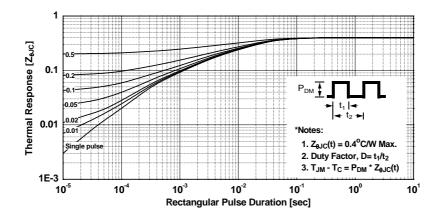
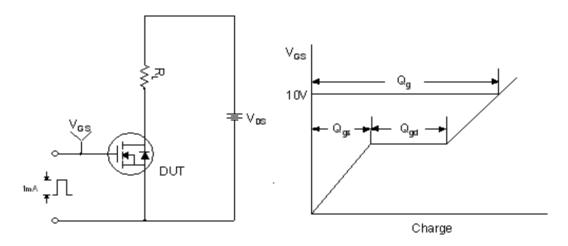


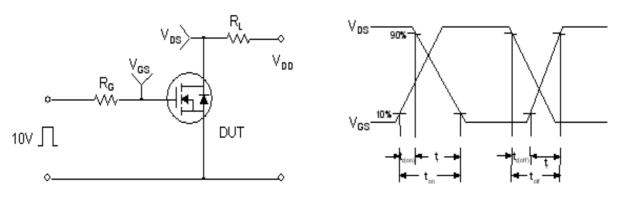
Figure 11. Transient Thermal Response Curve



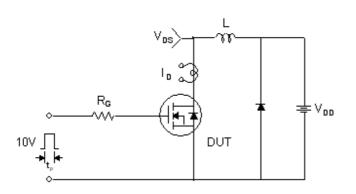
Gate Charge Test Circuit & Waveform

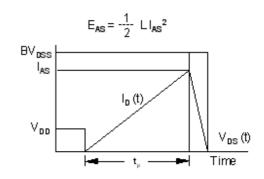


Resistive Switching Test Circuit & Waveforms

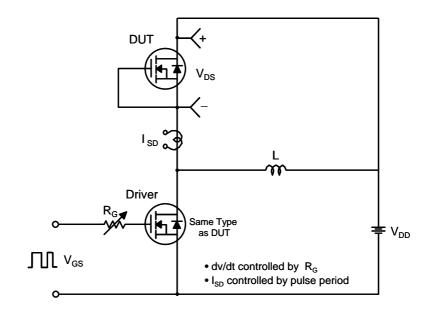


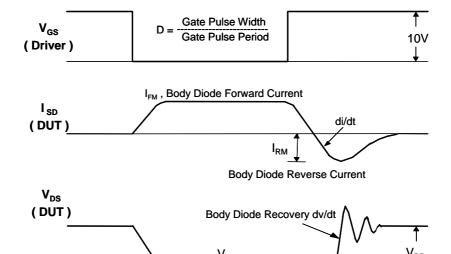
Unclamped Inductive Switching Test Circuit & Waveforms





Peak Diode Recovery dv/dt Test Circuit & Waveforms

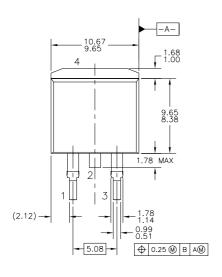


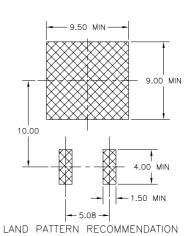


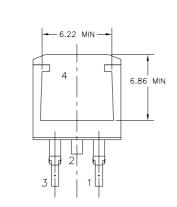
Body Diode Forward Voltage Drop

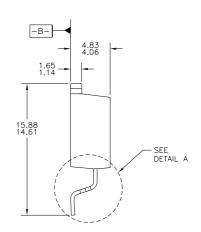
Mechanical Dimensions

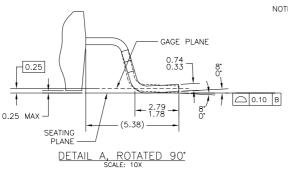
D2-PAK











TO263A02REVD

- NOTES: UNLESS OTHERWISE SPECIFIED

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 B) REFERENCE JEDEC, TO-263, ISSUE D, VARIATION AB, DATED JULY 2003.

 C) DIMENSIONING AND TOLERANCING PER ANSI Y14.5M 1982.

 D) LOCATION OF THE PIN HOLE MAY VARY (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE).

 B

 E) PRESENCE OF TRIMMED CENTER LEAD IS OPTIONAL.

Dimensions in Millimeters





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